UNR51AEG

Silicon PNP epitaxial planar type

For digital circuits

Features

- Costs can be reduced through downsizing of the equipment and reduction of the number of parts.
- SMini type package allowing easy automatic insertion through tape packing

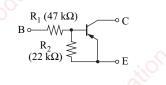
Absolute Maximum Ratings $T_a = 25^{\circ}C$						
Parameter	Symbol	Rating	Unit			
Collector-base voltage (Emitter open)	V _{CBO}	-50	V			
Collector-emitter voltage (Base open)	V _{CEO}	-50	V			
Collector current	I _C	-80	mA			
Total power dissipation	P _T	150	mW			
Junction temperature	Tj	150	°C			
Storage temperature	T _{stg}	-55 to +150	°C			





Package

- Marking Symbol: DL
- Internal Connection



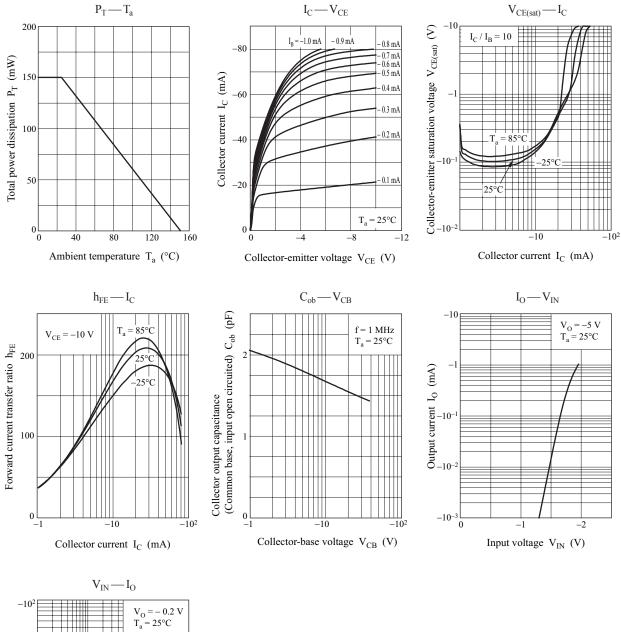
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

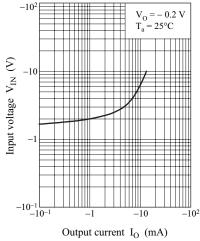
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = -10 \mu {\rm A}, I_{\rm E} = 0$	-50			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$	-50			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = -50 \text{ V}, I_E = 0$			- 0.1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{\rm CE} = -50$ V, $I_{\rm B} = 0$			- 0.5	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{\rm EB} = -6 V, I_{\rm C} = 0$			- 0.2	mA
Forward current transfer ratio	\mathbf{h}_{FE}	$V_{CE} = -10 \text{ V}, I_C = -5 \text{ mA}$	60			_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = -0.3 \text{ mA}$			- 0.25	V
Output voltage high-level	V _{OH}	$V_{CC} = -5 V$, $V_B = -0.5 V$, $R_L = 1 k\Omega$	-4.9			V
Output voltage low-level	V _{OL}	$V_{\rm CC} = -5 \text{ V}, \text{ V}_{\rm B} = -6 \text{ V}, \text{ R}_{\rm L} = 1 \text{ k}\Omega$			- 0.2	V
Input resistance	R ₁	2 ⁰⁻	-30%	47	+30%	kΩ
Resistance ratio	R_1/R_2		1.7	2.14	2.6	_
Transition frequency	\mathbf{f}_{T}	$V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$		80		MHz

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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Panasonic

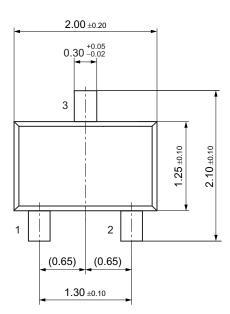


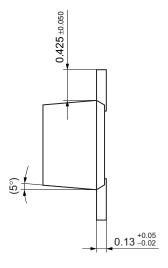


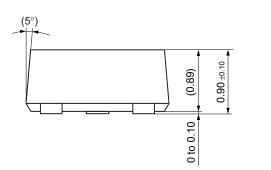
Panasonic

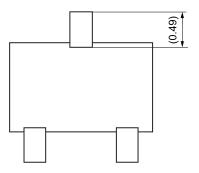
SMini3-F2

Unit: mm









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